Integrated Load Switch

FDC6329L

Description

This device is particularly suited for compact power management in portable electronic equipment where 2.5 V to 8 V input and 2.5 A output current capability are needed. This load switch integrates a small N-Channel power MOSFET (Q1) which drives a large P-Channel power MOSFET (Q2) in one tiny SUPERSOTTM-6 package.

Features

- $V_{DROP} = 0.20 \text{ V}$ @ $V_{IN} = 5 \text{ V}$, $I_L = 2.8 \text{ A}$, $R_{(on)} = 0.07 \Omega$
- $V_{DROP} = 0.20 \text{ V}$ @ $V_{IN} = 2.5 \text{ V}$, $I_L = 1.9 \text{ A}$, $R_{(on)} = 0.105 \Omega$
- Control MOSFET (Q1) Includes Zener Protection for ESD Ruggedness (> 6 kV Human Body Model)
- High Performance Trench Technology for Extremely Low On–Resistance
- SUPERSOT-6 Package Design Using Copper Lead Frame for Superior Thermal and Electrical Capabilities
- This is a Pb-Free and Halide Free Device

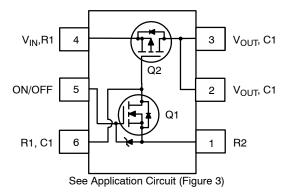


Figure 1.

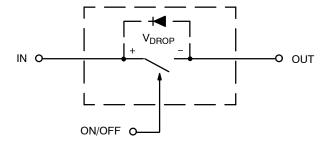


Figure 2. Equivalent Circuit



ON Semiconductor®

www.onsemi.com



TSOT-23-6 CASE 419BL

MARKING DIAGRAM



&E = Designates Space

&Y = Binary Calendar Year Coding Scheme

&. = Pin One Dot

329 = Specific Device Code

&G = Date Code

ORDERING INFORMATION

Device	Package	Shipping [†]
FDC6329L	TSOT-23-6 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

FDC6329L

ABSOLUTE MAXIMUM RATINGS T_A = 25°C unless otherwise noted

Symbol	Parameter	Value	Unit
V _{IN}	Input Voltage Range (Note 1)	2.5-8	V
V _{ON/OFF}	On/Off Voltage Range	1.5–8	V
IL	Load Current - Continuous (Note 2)	2.5	Α
	Load Current - Pulsed	10	1
P_{D}	Maximum Power Dissipation (Note 2)	0.7	W
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to 150	°C
ESD	Electrostatic Discharge Rating MIL-STD-883D Human Body Model (100 pF / 1500 Ω)	6	kV

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Value	Unit
$R_{ heta JA}$	Thermal Resistance, Junction-to-Ambient (Note 2)	180	°C/W
$R_{ heta JC}$	Thermal Resistance, Junction-to-Case (Note 2)	60	°C/W

ELECTRICAL CHARACTERISTICS T_A = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARAC	CTERISTICS					
I _{FL}	Forward Leakage Current	V _{IN} = 8 V, V _{ON/OFF} = 0 V	-	-	1	μΑ
ON CHARAC	TERISTICS (Note 3)					
V_{DROP}	Conduction Voltage	V _{IN} = 5 V, V _{ON/OFF} = 3.3 V, I _L = 2.8 A	-	0.12	0.2	V
		V _{IN} = 2.5 V, V _{ON/OFF} = 3.3 V, I _L = 1.9 A	-	0.14	0.2	
R _{DS(on)}	Q ₂ - Static On-Resistance	$V_{GS} = -5 \text{ V}, I_D = -2.5 \text{ A}$	-	0.047	0.07	Ω
		V _{GS} = -2.5 V, I _D = -2.0 A	-	0.073	0.105	
ΙL	Load Current	V _{DROP} = 0.2 V, V _{IN} = 5 V, V _{ON/OFF} = 3.3 V	2.8	-	-	Α
		V _{DROP} = 0.2 V, V _{IN} = 2.5 V, V _{ON/OFF} = 3.3 V	1.9	-	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

- 1. Range of V_{in} can be up to 8 V, but R_1 and R_2 must be scaled such that V_{GS} of Q2 does not exceed -8 V. 2. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design. 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.

FDC6329L

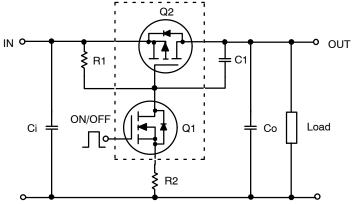


Figure 3. FDC6329L Load Switch Application

External Component Recommendation:

For applications where Co \leq 1 $\mu F.$ For slew rate control, select R2 in the range of 1k - 4.7 k $\Omega.$

For additional in–rush current control, C1 ≤ 1000 pF can be added.

Select R1 so that the R1/R2 ratio ranges from 10 - 100. R1 is required to turn Q2 off.

TYPICAL CHARACTERISTICS

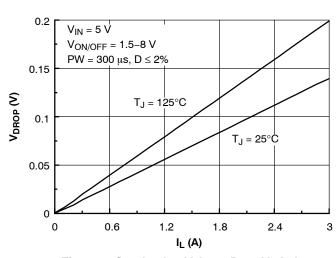


Figure 4. Conduction Voltage Drop Variation with Load Current

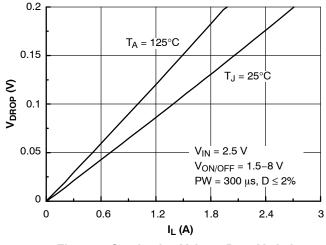


Figure 5. Conduction Voltage Drop Variation with Load Current

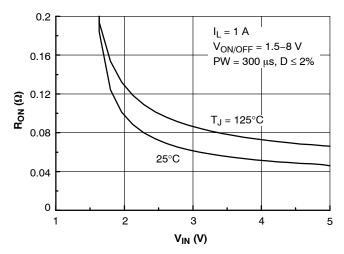


Figure 6. On-Resistance Variation with Input Voltage

FDC6329L

TYPICAL CHARACTERISTICS (continued)

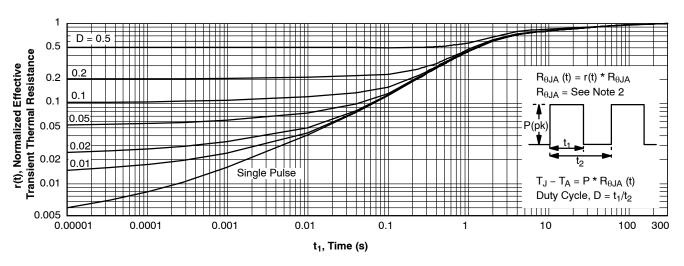


Figure 7. Transient Thermal Response Curve

NOTE: Thermal characterization performed on the conditions described in Note 2.

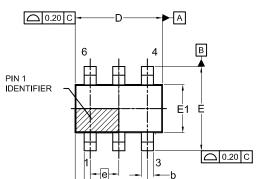
Transient thermal response will change depending on the circuit board design.

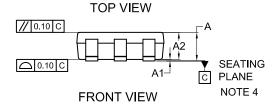
SUPERSOT is a trademark of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries.



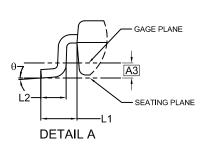
TSOT23 6-Lead CASE 419BL **ISSUE A**

DATE 31 AUG 2020





e1





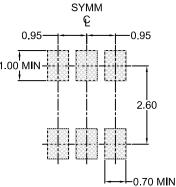
NOTES:

SEE DETAIL A

SIDE VIEW

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
- CONTROLLING DIMENSION: MILLIMETERS
 DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH,
 PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.25MM PER END. DIMENSIONS D AND E1 ARE DETERMINED AT DATUM H.
- 4. SEATING PLANE IS DEFINED BY THE TERMINALS. "A1" IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY.

DIM	MILLIMETERS			
J	MIN.	NOM.	MAX.	
Α	0.90	1.00	1.10	
A1	0.00	0.05	0.10	
A2	0.70	0.85	1.00	
A3	0.25 BSC			
b	0.25	0.38	0.50	
С	0.10	0.18	0.26	
D	2.80	2.95	3.10	
d	0.30 REF			
Е	2.50 2.75 3.00			
E1	1.30	1.50	1.70	
е	0.95 BSC			
e1	1.90 BSC			
L1	0.60 REF			
L2	0.20	0.40	0.60	
θ	0°		10°	



LAND PATTERN RECOMMENDATION

*FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code

= Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ", may or may not be present. Some products may not follow the Generic Marking.

DOCUMENT NUMBER:	98AON83292G	Electronic versions are uncontrolled except when accessed directly from the Document Repositor Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	TSOT23 6-Lead		PAGE 1 OF 1	

ON Semiconductor and unare trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT: Email Requests to: orderlit@onsemi.com

onsemi Website: www.onsemi.com

TECHNICAL SUPPORT North American Technical Support: Voice Mail: 1 800–282–9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative